

| DESIGN CHECKLIST | | | | | | | | | |
|------------------|--------|-------------|-----------|-----|---------|-----|---|--|---|
| PIN NAME | | REQUIREMENT | COMPONENT | MIN | TYP | MAX | DESCRIPTION | COMMENTS AND RELEVANT EQUATIONS | PCB Placement |
| na | na | Recommended | RIN | | 2 Ω | | Input hot plug filter | | |
| na | na | Recommended | CIN | | 2.2 uF | | | | Place close to input adapter port |
| na | na | Recommended | Q1 | | * | | Soft start FET | | |
| na | na | Recommended | Q2 | | * | | Reverse blocking FET | If not used, a reverse blocking diode is recommended | |
| na | na | Optional | CGS | | * uF | | Soft start capacitor | To limit input surge current, external CGS at least 10 X FETs combined CGS can be added. | |
| na | na | Optional | RGS | | 499 kΩ | | Pull down resistor | Required for 1S Lilon applications; recommended for all applications | |
| CMSRC | 7 | Required | R12 | | 4.02 kΩ | | Common source connection for input NFETs | | |
| ACDRV | 8 | Required | R11 | | 4.02 kΩ | | Charge pump output for turning on input NETs | | |
| AVCC | 4 | Required | C1 | | 1 uF | | IC input supply | C1 minimum voltage rating of 1.5 x maximum DC input voltage. R10 is 10 Ω unless input power is 5-V then reduce to 5 Ω. | Place capacitor close to IC pin and PGND, priority 1 |
| | | | R1 | | 10 Ω | | | | |
| | | | D1 & D2 | | 0.1 A | | Schottky diode OR | Low current diode (BAT54) to allow charger to be powered from battery when no input power applied | |
| VREF | 12 | Required | C2 | | 1 uF | | 3.3V reference voltage output for resistor bias | | Place near to IC pin and AGND, priority 3 |
| TTC | 11 | Required | C3 | | 0.1 uF | | Safety timer and termination control | Sets the fast charge safety timer (5.6 min/nF). Pull the TTC to LOW to disable the charge termination and safety timer. Pull the TTC to HIGH to disable the safety timer but allow the charge termination. | Place near to IC pin and AGND, priority 3 |
| ACP | 6 | Optional | not shown | | 0.1 uF | | Input current limit common mode filter capacitor | If input current limit not used, do not install and short ACP=ACN. | Place from ACP pin to AGND. Kelvin connect to ACP pin. |
| ACN | 5 | Required | C12 | | 0.1 uF | | Input current limit common mode filter capacitor | If input current limit not used, do not install and short ACP=ACN. | Place from ACN pin to AGND. Kelvin connect to ACN pin. |
| ACPtoACN | 5 to 6 | Required | RAC | | *Ω | | Input current sense resistor | IDPM = VACSET/(20xRAC) If input current limit not used, do not install and short ACP=ACN. Use current sense, low inductance resistor with appropriate current rating. | |
| | | Required | C11 | | 0.1 uF | | Input current limit differential filter capacitor | If input current limit not used, do not install and short ACP=CAN. An optional 0.1 uF capacitor from ACN to AGND can be used for improved common mode filtering. | Place across RAC input current limit resistor. Kelvin connect to ACP pin. |
| TS | 10 | Required | R8 (RT1) | | *Ω | | Resistor divider to set window for thermistor temperature-based battery charging profile | $RT1 = \frac{\left(\frac{1}{V_{T1}} - 1\right)}{\left(\frac{1}{RT2} + \frac{1}{R_{NTC,T1}}\right)}$ | |
| | | Required | R9 (RT2) | | *Ω | | | | |
| | | | | | | | If TS feature not used, use equations to set V(TS) to ~60% of VREF. | | |
| | | | | | | | See design xls at http://www.ti.com/lit/zip/sluc244 | | |
| OVPSET | 18 | Required | R6 | | *Ω | | Resistor divider to set input over voltage and under voltage thresholds | $V_{ACOV} = 1.6V (R6/R7+1)$ $V_{ACUV} = 0.5V (R6/R7+1)$ | Connect R7 to AGND. Kelvin connect resistor midpoint pin routed away from traces/pours/planes with switching noise. Add an optional 330pF capacitor from OVPSET to ground if noisy supply or fast transients. |
| | | Required | R7 | | *Ω | | | Recommended to set R7 = 402kΩ and solve for R6 See design xls at http://www.ti.com/lit/zip/sluc244 | |
| ISET | 13 | Required | R2 | | *Ω | | Resistor divider to set maximum charge current | $V_{ISET} = VREF * R3/(R2+R3)$ $I_{CHARGE} = V_{ISET}/(20xRSR)$ | Connect R3 to AGND. Kelvin connect resistor divider midpoint to pin routed away from traces/pours/planes with switching noise. |
| | | Required | R3 | | *Ω | | | Recommended to set R2 = 100kΩ and solve for R3 See design xls at http://www.ti.com/lit/zip/sluc244 | |

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| ACSET | 17 | Required | R4 | | *Ω | Resistor divider set maximum input (adapater) current | $V_{ACSET} = VREF * R5 / (R4 + R5)$ $I_{DPM} = V_{ACSET} / (20 * RAC)$ Recommended to set R4 = 100kΩ and solve for R5 See design xls at http://www.ti.com/lit/zip/sluc244 | Connect R5 to AGND. Kelvin connect resistor divider midpoint to pin routed away from traces/pours/planes with switching noise. | |
| | | Required | R5 | | *Ω | | | | |
| STAT | 10 | Recommended | R10 | | *kΩ | LED pull up resistor | | | |
| | | Optional | D3 | | | Charging status indicating LED | | | |
| SW | 1, 24 | Required | L | | 3.3 | Inductor connection | For BQ24133, refer to datasheet table 5 For BQ2417x, refer to datasheet table 3 | | |
| | | Optional | D4 | | | Low side Schottky diode | Increases efficiency by reducing the drop across the low side FET body diode. Sized for conduction only for duty < 10% * (1-D) | Place close to IC pin and PGND, priority 1. If placed on bottom layer, use multiple vias back to top. | |
| | | Optional | RSNUB, CSNUB | | | RC snubber to reduce EMI | 603 footprint components, sized on working PCB using empirical measurements. Decreases efficiency by ~0.5% when properly sized | Place close to IC pin and PGND, priority 1. If placed on bottom layer, use multiple vias back to top. | |
| BTST to SW | 21 to 1,24 | Required | C5 | 0.047 uF | | | | Place close to IC pin and PGND, priority 2. | |
| | | Optional | RBTST | 1 Ω | | 10 Ω | Slows down the FET turn on time which can reduce EMI. Sized empirical. Will reduce efficiency by up to 1%. | | |
| SRP | 16 | Required | C7 | | 0.1 uF | Input current limit common mode filter capacitor | If input current limit not used, do not install and short ACP=ACN. | Place capacitor from IC pin to AGND. Kelvin connect to IC pin and avoid traces/pours/planes with switching noise. | |
| SRPtoSRN | 15 to 16 | Required | RSR | | *Ω | Input current sense resistor | $V_{ISET} = VREF * R3 / (R2 + R3)$ $I_{CHARGE} = V_{ISET} / (20 * RSR)$ Recommended to set R2 = 100kΩ and solve for R3 See design xls at http://www.ti.com/lit/zip/sluc244 | | |
| | | Required | C8 | | 0.1 uF | Input current limit differential filter capacitor | If input current limit not used, do not install and short ACP=CAN. An optional 0.1 uF capacitor from ACN to AGND can be used for improved common mode filtering. | Place across RAC input current limit resistor. Kelvin connect to ACP pin. | |
| SRN | 15 | Optional | C _{DCP_BAT} | 0.01 uF | | 0.1uF | Buck output decoupling capacitor | Helpful in reducing output ripple and EMI | Place close to IC pin and PGND, priority 2. |
| | | Required | C9 & C10 | 10 uF | 20 uF | | Buck output bulk capacitance near charger IC | Minimum recommended is 10 uF; typical is 20 uF For BQ24133, refer to datasheet table 5 For BQ2417x, refer to datasheet table 3 | Place close to IC pin and PGND, priority 3. Kelvin connect to IC pin and avoid traces/pours/planes with switching noise. |
| PVCC | 2, 3 | Optional | C _{DCP_VCC} | 0.01 uF | | 0.1uF | Buck input decoupling capacitance | Most important capacitor for minimizing EMI | Place close to IC pin and PGND, priority 1. |
| | | Required | C4 | 10 uF | | | Buck input bulk capacitance | | Place close to IC pin and PGND, priority 1. |
| REGN | 20 | Required | C6 | 1 uF | | | REGN linear regulation output capacitor | | Place close to IC pin and PGND, priority 1. |
| CELL | 14 | Required | na | | na | | Sets CV regulation point for 133/170 | Set CELL pin LOW for 1-cell, Float for 2-cell (0.8 V - 1.8 V), and HIGH for 3- cell with a fixed 4.2 V per cell. | |
| FB | 14 | Required | RTOP, RBOT | | * | | Sets CV regulation point for 171/172 | $VBATREG = 2.1 V * (1 + RTOP/RBOT)$ Recommended to set RBOT = 100kΩ and solve for RTOP See design xls at http://www.ti.com/lit/zip/sluc244 | Place resistors close to IC pin and AGND. |